

TDA9207

150 MHz PIXEL VIDEO CONTROLLER FOR MONITORS INCLUDING CUT-OFF INPUTS

FEATURE

- 150 MHZ PIXEL RATE
- 2.7 ns RISE AND FALL TIME
- I²C BUS CONTROLLED
- GREY SCALE TRACKING VERSUS BRIGHT-NESS
- OSD MIXING
- NEGATIVE FEED-BACK FOR DC COUPLING APPLICATION
- INTERNAL POSITIVE FEED-BACK FOR LCD APPLICATION
- 0.5~4.5 V DACs FOR BLACK LEVEL RESTO-RATION (AC-COUPLING APPLICATION) OR CUT-OFF CONTROLS (FOR DC-COUPLING APPLICATION USING THE ST AMPLIFIERS TDA9533/9530)
- BEAM CURRENT ATTENUATION (ABL)
- PEDESTRAL CLAMPING ON OUTPUT STAGE
- POSSIBILITY OF LIGHT OR DARK GREY OSD BACKGROUND
- OSD INDEPENDENT CONTRAST CONTROL
- ADJUSTABLE BANDWIDTH
- INPUT BLACK LEVEL CLAMPING WITH BUILT-IN CLAMPING PULSE
- STAND-BY MODE
- 5 V TO 8 V POWER SUPPLY
- SYNC CLIPPING FUNCTION (SOG)

DESCRIPTION

The TDA9207 is an I^2C Bus controlled RGB preamplifier designed for Monitor application, able to mix the RGB signals coming from any OSD device. The usual Contrast, Brightness, Drive and Cut-Off Controls are provided.

In addition, it includes the following features:

- OSD contrast,
- Bandwidth adjustment,
- Grey background,
- Internal back porch clamping pulse generator.



The RGB incoming signals are amplified and shaped to drive any commonly used video amplifiers without intermediate follower stages. Even though encapsulated in a 24-pin package only, this IC allows any kind of CRT Cathode coupling :

- AC coupling with DC restore,

- DC coupling with Feed-back from Cathodes,
- DC coupling with Cut-Off controls of the Video amplifier (ST Amplifiers TDA9533/9530).

As for any ST Video pre-amplifier, the TDA9207 is able to drive a real load without any external interface.

One of the main advantages of ST devices is their ability to sink and source currents while most of the devices from our competitors have problems to sink large currents.

These driving capabilities combined with an original output stage structure suppress any static current on the output pins and therefore reduce dramatically the power dissipation of the device.

Extensive integration combined with high performance and advanced features make the TDA9207 one of the best choice for any CRT Monitor in the 14" to 17" range.

Perfectly matched with the ST Video Amplifiers TDA9530/33, these 2 products offer a complete solution for high performance and cost-optimized Video Board Application.

Version 4.2

1 - PIN CONNECTIONS

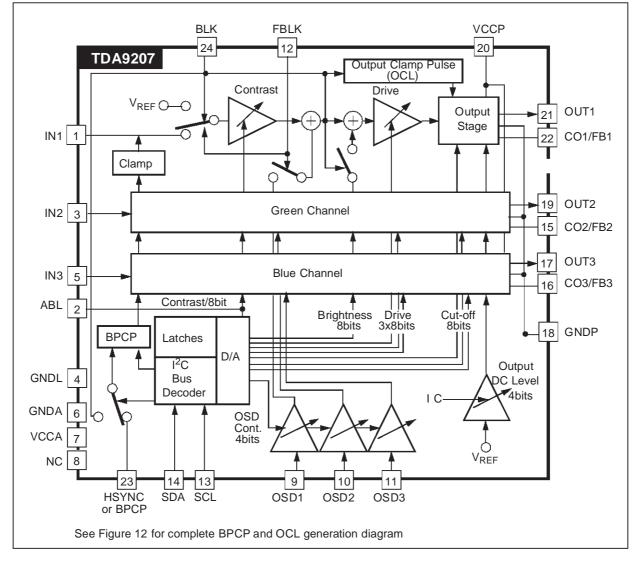
ABL 2 2 IN2 3 2 GNDL 4 2 IN3 5 2 GNDA 6 1 V _{CCA} 7 1 NC 8 1 OSD1 9 1 OSD2 10 1 OSD3 11 1	24 BLK 23 HSYNC or BPCP 22 CO1/FB1 21 OUT1 20 V _{CCP} 19 OUT2 18 GNDP 17 OUT3 16 CO3/FB3 15 CO2/FB2 14 SDA 13 SCL
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2 - PIN DESCRIPTION

Pin Number	Symbol	Description
1	IN1	Red Video Input
2	ABL	ABL Input
3	IN2	Green Video Input
4	GNDL	Logic Ground
5	IN3	Blue Video Input
6	GNDA	Analog Ground
7	V _{CCA}	Analog V _{CC} (5V)
8	NC	Not Connected
9	OSD1	Red OSD Input
10	OSD2	Green OSD Input
11	OSD3	Blue OSD Input
12	FBLK	Fast Blanking
13	SCL	SCL
14	SDA	SDA
15	CO2/FB2	Green Cut-off Output/Feedback Input
16	CO3/FB3	Blue Cut-off Output/Feedback Input
17	OUT3	Blue Video Output
18	GNDP	Power Ground
19	OUT2	Green Video Output
20	V _{CCP}	Power V _{CC} (5 V to 8 V)
21	OUT1	Red Video Output
22	CO1/FB1	Red Cut-off Output/Feedback Input
23	HSYNC BPCP	HSYNC BPCP
24	BLK	Blanking Input



3 - BLOCK DIAGRAM



4 - FUNCTIONAL DESCRIPTION

4.1 RGB Input

The three RGB inputs have to be supplied through coupling capacitors (100 nF).

The maximum input peak-to-peak video amplitude is 1 V.

The input stage includes a clamping function. The clamp uses the input serial capacitor as a "memo-ry capacitor".

To avoid a discharge of the serial capacitor during the line (due to leakage current), the input voltage is referenced to the ground.

The clamp is gated by an internally generated "Back Porch Clamping Pulse" (BPCP). Register 8 allows to choose the way to generate this BPCP (see Figure 1).

When bit 0 is set to 0, the BPCP is synchronized on the trailing or leading edge of HSYNC (Pin 23) (bit 1 = 0: trailing edge, bit 1 = 1: leading edge).

Additionally, the IC automatically works with either positive or negative HSYNC pulses.

- When bit 0 is set to 1, BPCP is synchronized on the leading edge of the blanking pulse BLK (Pin 24). One can use a positive or negative blanking pulse by programming bit 0 in Register 9 (See I²C Table 3).
- BPCP width can be adjusted with bit 2 and 3 (see Register 8, I²C table 2).
- If the application already provides the Back Porch Clamping Pulse, bit 4 must be set to 1 (providing a direct connection between Pin 23 and internal BPCP).

4.2 Synchro Clipping Function

This function is available on channel 2 (Green Channel). When using the Sync On Green (SOG) (Synchro pulse included in the green channel in-

Figure 1.

put) the synchro clipping function must be activated (bit 7 set to 1 in register 9) in order to keep the right green output levels and avoid unbalanced colours.

4.3 Blanking Input

The Blanking pin (FBLK) is TTL compatible.

The Blanking pulse can be:

- positive or negative
- line or Composite-type (but not Frame-type).

4.4 Contrast Adjustment (8 bits)

The contrast adjustment is made by controlling simultaneously the gain of the three internal amplifiers through the l^2C bus interface. Register 1 allows the adjustment in a range of 48 dB.

R8b0=0 and R8b1=0 HSYNC/BPCP (Pin23)
Internal BPCP
R8b0=0 and R8b1=1 HSYNC/BPCP (Pin23)
Internal BPCP
R8b0=1 BLK (Pin24)
Internal BPCP
R8b4 =1 HSYNC/BPCP (Pin23)
Internal BPCP

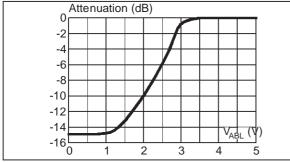
4.5 ABL Control

The TDA9207 includes an ABL (automatic beam limitation) input to attenuate the RGB Video signals depending on the beam intensity.

The operating range is 2 V (from 3 V to 1 V). A typical 15 dB maximum attenuation is applied to the output signal whatever the contrast adjustment is. (See Figure 2).

When the ABL feature is not used, the ABL input (Pin 2) must be connected to a 5 V supply voltage.

Figure 2.



4.6 Brightness Adjustment (8 bits)

Brightness adjustment is controlled by the I²C Bus via Register 2. It consists of adding the same DC voltage to the three RGB signals, after contrast adjustment. When the blanking pulse equals 0, the DC voltage is set to a value which can be adjusted between 0 and 2V with 8mV steps (see Figure 3).

The DC output level is forced to the "Infra Black" level (V_{DC}) when the blanking pulse is equal to 1.

4.7 Drive Adjustment (3 x 8 bits)

In order to adjust the white balance, the TDA9207 offers the possibility of adjusting separately the overall gain of each channel thanks to the I^2C bus (Registers 3, 4 and 5).

The very large drive adjustment range (48 dB) allows different standards or custom color temperatures.

It can also be used to adjust the output voltages at the optimum amplitude to drive the CRT drivers, keeping the whole contrast control for the enduser only.

The drive adjustment is located after the Contrast, Brightness and OSD switch blocks, so it does not affect the white balance setting when the BRT is adjusted. It also operates on the OSD portion of the signal.

4.8 OSD Inputs

The TDA9207 allows to mix the OSD signals into the RGB main picture. The four pins dedicated to this function are the following:

- Three TTL RGB inputs (Pins 9, 10, 11) connected to the three outputs of the corresponding OSD processor.
- One TTL fast blanking input (Pin 12) also connected to the FBLK output of the OSD processor.

When a high level is present on the FBLK, the IC acts as follows:

- The three main picture RGB input signals (IN1, IN2, IN3) are internally switched to the internal input clamp reference voltage.
- The three output signals are set to the voltage corresponding to the three OSD input logic states (0 or 1). (See Figure 3).

If the OSD input is at low level, the output and brightness voltages (V_{BRT}) are equal.

If the OSD input is at high level, the output voltage is V_{OSD} , where $V_{OSD} = V_{BRT} + OSD$ and OSD is an I²C bus-controlled voltage.

OSD varies between 0 V to 4.9 V by 320 mV steps via Register 7 (4 bits). The same variation is applied simultaneously to the three channels providing the OSD contrast.

The grey color can be obtained on output signals when:

- OSD1 = 1, OSD2 = 0 and OSD3 = 1,

- A special bit (bit 5 or 6) in Register 9 is set to 1.

If R9b5 is set to 1, light grey is obtained on output.

If R9b6 is set to 1, dark grey is obtained on output.

In the case where R9b5 and R9b6 are set to 0, the normal operation is provided on output signals.

4.9 Output Stage

The overall waveforms of the output signal are shown in Figure 3 and Figure 4. The three output stages, which are large bandwidth output amplifiers, are able to deliver up to 4.4 V_{PP} for 0.7 V_{PP} on input.

When a high level is applied on the BLK input (Pin 24), the three outputs are forced to "Infra Black" level (V_{DC}) thanks to a sample and hold circuit (described below).

The black level (which is the output voltage outside the blanking pulse with minimum brightness and no Video input signals) is 400 mV higher than $V_{\rm DC}.$

The brightness level (V_{BRT}) is then obtained by programming register 2 (see I 2 C table 1).

The sample and hold circuit is used to control the "Infra Black" level in the range of 0.5 V to 2.5 V via Register 6 (in case of AC coupling) or Registers 10, 11, 12 (in case of DC coupling).

This sampling occurs during an internal pulse (OCL) generated inside the blanking pulse window.

Refer to "CRT cathode coupling" part for further details.



Functioning with 5 V Power V_{CC}

To simplify the application, it is possible to supply the power V_{CC} with 5 V (instead of 8 V nominal) at the expense of output swing voltage.

Functioning without Blanking Pulse

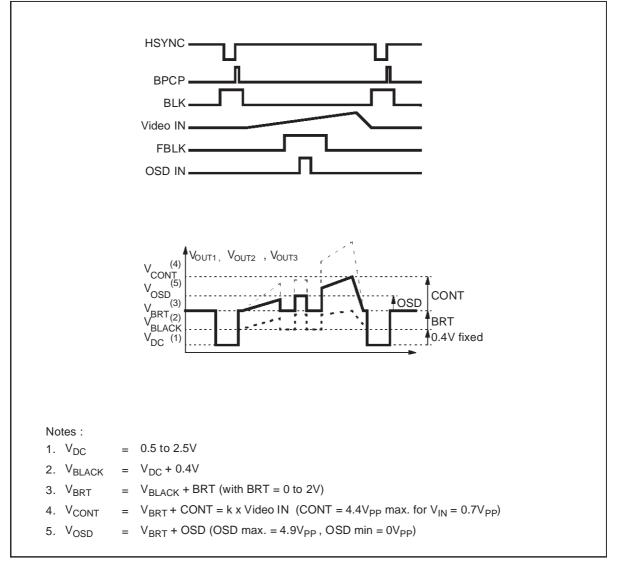
If no blanking pulse is applied to the TDA9207, the internal BPCP can be connected to the sample

Figure 3. Waveforms VOUT, BRT, CONT, OSD

and hold circuit (Register 8, bit 7 = 1 and BLK pin grounded) so that the output DC level is still controlled by l^2C .

To ensure the device correct behavior in the worst possible conditions, the Brightness Register must be set to 0.

*[*577



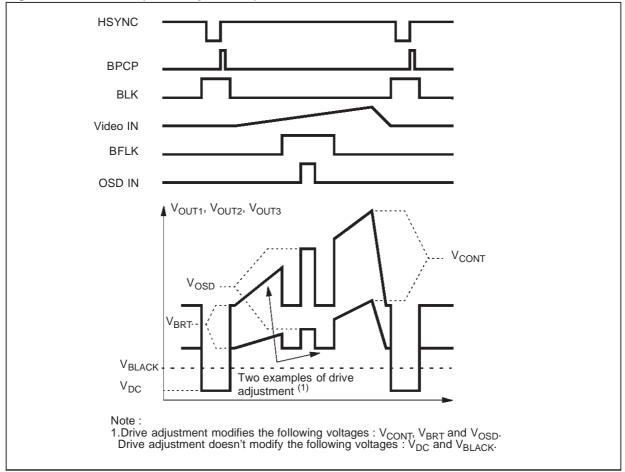


Figure 4. Waveforms (Drive adjustment)

4.10 Bandwidth Adjustment

A new feature: Bandwidth adjustment, has been implemented on the TDA9207.

This function has several advantages:

- Depending on the external capacitive load and on the peak-to-peak output voltage, the bandwidth can be adjusted to avoid any slew-rate phenomenon.
- The preamp bandwidth can be adjusted in order to reduce electromagnetic radiation, since it is possible to slow down the signal rise/fall time at the CRT driver input without too much affecting the rise/fall time at the CRT driver output.
- It is possible to optimize the ratio of the frequency response versus the CRT driver power consumption for any kind of chassis, as the preamp bandwidth adjustment also allows the adjustment of the rise/fall time on the cathode (through the CRT driver).

 In still picture mode, when a high Video swing voltage is of greater interest than rise/fall time, bandwidth adjustment is used to avoid any slewrate phenomenon at the CRT driver output and to meet electromagnetic radiation requirements.

4.11 CRT Cathode Coupling

The powerfull multiplex capability of the TDA9207 allows to use the device with several kinds of CRT cathode coupling.

4.11.1 AC coupling with DC restore (Figure 5)

In this mode the output DC level (V_{DC}) is adjusted simultaneously for the 3 channels from 0.5 V to 2.35 V via Register 6 (4 bits). The cut-off voltage is programmed independently for each channel from 0.17 V to 4.6 V using registers 10, 11, 12 (8 bits each, see l^2C Table 1).

4.11.2 DC Coupling with cut-off controls on Video Amplifier (with TDA9533/ 9530, Figure 6)

The functioning and programming of the TDA9207 are the same as for the previous mode, except for

4.11.3 DC Coupling Mode (Figure 7)

This is the most commonly used configuration enabling to build a powerful video system on a small PCB Board and giving a substantial cost saving compared with any other solution available on the market.

The preamplifier outputs control directly the cut-off levels.

The output DC level (VDC) is adjusted independently for each channel from 0.5 V to 2.5 V via registers 10, 11 and 12.

In DC coupling mode, bit 2 must be set to 1 and bit3 to 0 in Register 9.

the cut-off control which is now performed via the Video amplifier cut-off input .

In AC coupling and DC coupling with cut-off control, bits 2, 3 and 4 in Register 9 must be set to 1.

4.11.4 DC Coupling with feedback mode (Fig. 8)

In this mode, the feedback voltage issued from the cathode is sent to the TDA9207. This voltage is compared to a reference from the cut-off DC level DAC by the sample and hold circuit who also controls the DC voltage of the feedback input in a range of 0.5 V to 2.5 V.

Each channel is independently controlled via Registers 10, 11 and 12.

In DC coupling with feedback mode, bit 2 and bit 4 must be set to 0 in Register 9.

*[*5]

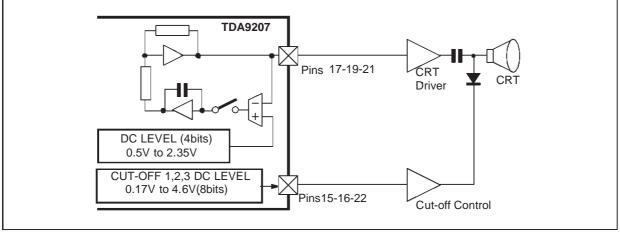


Figure 6. DC Coupling with Cut-off Control

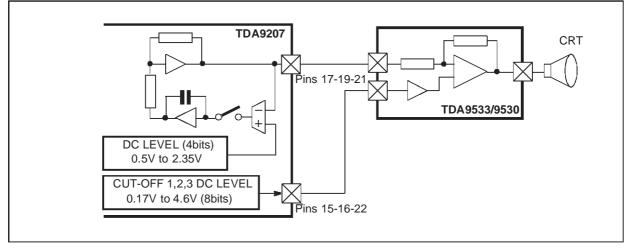


Figure 5. AC Coupling



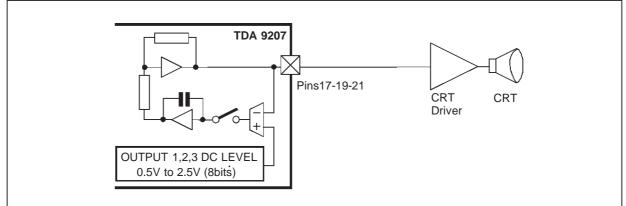
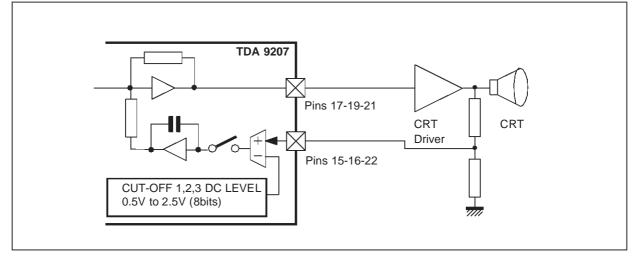


Figure 8. DC Coupling with Feedback (LCD mode)



4.12 Stand-by Mode

The TDA9207 has a stand-by mode. As soon as the V_{CC} power (Pin 20) gets lower than 3V (typ.), the device is set in stand-by mode whatever the voltage on analog V_{CCA} (Pin 7) is. The analog blocks are internally switched-off while the logic parts (l^2C bus, power-on reset) are still supplied.

In stand-by mode, the power consumption is below 20 mW.

4.13 Serial Interface

The 2-wire serial interface is an I^2C interface. The slave address of TDA9207 is DC hex.

A6	A5	A4	A3	A2	A1	A0	W
1	1	0	1	1	1	0	0

The host MCU can write into the TDA9207 registers. Read mode is not available.

In order to write data into the TDA9207, after the "start" message, the MCU must send the following data (see Figure 9):

- the I^2C address slave byte with a low level for the R/W bit,
- the byte to the internal register address where the MCU wants to write data,
- the data.

All bytes are sent with MSB bit first. The transfer of written data is ended with a "stop" message.

When transmitting several data, the register addresses and data can be written with no need to repeat the start and slave addresses.



4.14 Power-on Reset

A power-on reset function is implemented on the TDA9207 so that the $\rm l^2C$ registers have a determined status after power-on. The Power-on reset

threshold for a rising supply on V_{CCA} (Pin 7) is 3.8 V (typ.) and 3.2V when the V_{CC} decreases.

Figure 9. I²C Write Operation

				ЛЛЛ	\sim	
SDA		A7	X A6 X A5 X A4 X A3 X A2 X A1			
Start	I ² C Slave Address	ACK	Register Address	ACK	Data Byte	ACK Stop



5 - ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Pin	Value	Units
V _{CCA} Max. V _{CCP} Max.	Supply Voltage on Analog V_{CC} Supply Voltage on Power V_{CC}	7 20	5.5 8.8	V V
V _{in} Max.	Voltage at any Input Pins (except Video inputs) and Input/Output Pins	-	5.5	V
V _I Max.	Voltage at Video Inputs	1, 3, 5	1.4	V
T _{stg}	Storage Temperature	-	-	°C
T _{oper}	Operating Junction Temperature	-	+150	°C

6 - THERMAL DATA

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Symbol	Parameter	Value	Units
R _{th(j-a)}	Max. Junction-ambient Thermal Resistance	69	°C/W
Тj	Typ. Junction Temperature at $T_{amb} = 25^{\circ}C$	80	°C

7 - DC ELECTRICAL CHARACTERISTICS

 T_{amb} = 25°C, V_{CCA} = 5V, V_{CCP} = 8V, unless otherwise specified.

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
V _{CCA}	Analog Supply Voltage	Pin 7	4.5	5	5.5	V
V _{CCP}	Power Supply Voltage	Pin 20	4.5	8	8.8	V
I _{CCA}	Analog Supply Current	V _{CCA} = 5V		70		mA
I _{CCP}	Power Supply Current	V _{CCP} = 8V		55		mA
VI	Video Input Voltage Amplitude			0.7	1	V
Vo	Output Voltage Range		0.5		V _{CCP} -0.5V	V
VIL	Low Level Input Voltage	OSD, FBLK, BLK, HSYNC			0.8	V
V _{IH}	High Level Input Voltage		2.4			V
I _{IN}	Input Current	OSD, FBLK, BLK	-1		1	μΑ
R _{HS}	Input Resistor	HSYNC		40		kΩ

8 - AC ELECTRICAL CHARACTERISTICS

 $\begin{array}{l} \mathsf{T}_{\mathsf{amb}} = 25^\circ C, \ \mathsf{V}_{CCA} = 5\mathsf{V}, \ \mathsf{V}_{CCP} = 8\mathsf{V}, \ \mathsf{V}_i = 0.7 \ \mathsf{V}_{PP}, \ C_{LOAD} = 5\mathsf{pF} \\ \mathsf{R}_S = 100\Omega, \ \text{serial between output pin and } C_{LOAD}, \ \text{unless otherwise specified.} \end{array}$

Max. Units Parameter **Test Conditions** Min. Symbol Тур. VIDEO INPUTS (PINS 1, 3, 5) Video Input Voltage Amplitude Vi Max. Contrast and Drive 0.7 1 V VIDEO OUTPUT SIGNAL (PINS 17, 19, 21) - GENERAL GAM Maximum Gain Max Contrast and Drive 16 dB (CRT = DRV = 254 dec)VOM Maximum Video Output Voltage Max Contrast and Drive 4.4 V (CRT = DRV = 254 dec)(Note) VON Contrast and Drive at POR V 2.2 Nominal Video Output Voltage (CRT = DRV = 180 dec)From max. Contrast (CRT=254 dec) CAR dB Contrast Attenuation Range 48 to min. Contrast (CRT = 1 dec) DAR **Drive Attenuation Range** From Max. Drive (DRV = 254 dec) 48 dB to min Drive (DRV = 1 dec) GM Contrast and Drive at POR dB Gain Matching ±0.1 $V_{OUT} = 2 V_{PP} (BW = 15 dec)$ 27 ns t_R, t_F Rise Time, Fall Time (Note) $V_{OUT} = 2 V_{PP} (BW = 0 dec)$ 4.3 ns BW Large Signal Bandwidth 130 MHz $V_{OUT} = 2 V_{PP}$ BW Bandwidth Adjustment Range $V_{OUT} = 2 V_{PP}$ Minimum bandwidth (BW = 0 dec) 80 MHz Maximum bandwidth (BW =15 dec) 130 MHz CT Crosstalk between Video Outputs @ f = 10 MHz 60 dB $V_{OUT} = 2 V_{PP}$ @ f = 50 MHz 35 dB VIDEO OUTPUT SIGNAL — BRIGHTNESS BRTmax Maximum Brightness Level Max. Brightness (BRT = 255 dec) 2 V and Max. Drive (DRV = 254 dec) Min. Brightness (BRT = 0 dec) BRTmin Minimum Brightness Level 0 V and Max. Drive (DRV = 254 dec)

VIDEO OUTPUT SIGNAL — OSD

Insertion Pulse

Brightness Matching

		Max. Drive (DRV = 254 dec)					
OSDmax	Maximum OSD Output Level	Max. OSD (OSD = 15 dec)		4.9		V	
OSDmin	Minimum OSD Output Level	Min. OSD (OSD = 0 dec)		0		V	
VIDEO OL	VIDEO OUTPUT SIGNAL — DC LEVEL (AC COUPLING MODE)						

Brightness and Drive at POR

DCLmax	Maximum Output DC Level	Max. DCL (DCL= 15 dec)		2.35		V
DCLmin	Minimum Output DC Level	Min. DCL (DCL = 3 dec)		0.5		V
DCLstep	Output DC Level Step			155		mV
VIDEO OUTPUT SIGNAL — DC LEVEL (DC COUPLING MODE)						

		/		
DCLmax	Maximum Output DC Level	Max. Cut-off (Cut-off = 255 dec)	2.5	V
DCLmin	Minimum Output DC Level	Min. Cut-off (Cut-off = 40 dec)	0.4	V
DCLstep	Output DC Level Step		10	mV

Assuming that V_{OM} remains within the range of Vo (between 0.5V and V_{CCP} - 0.5V)

 t_R , t_F are calculated values, assuming an ideal input rise/fall time of Ons ($t_R = \sqrt{t_{ROUT}^2 + t_{RIN}^2}$, $t_F = \sqrt{t_{FOUT}^2 + t_{FIN}^2}$

VIP

BRTM

V

m٧

0.4

±10

AC ELECTRICAL CHARACTERISTICS (continued)

 $T_{amb} = 25^{\circ}C, \ V_{CCA} = 5V, \ V_{CCP} = 8V, \ V_i = 0.7 \ V_{PP}, \ C_{LOAD} = 5 \ pF, \ unless \ otherwise \ specified$

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units	
CUT-OFF OUTPUTS (AC COUPLING MODE) - (Pins 15, 16, 22)							
COmax	Maximum Cut-off Output Level	Max. Cut-off (Cut-off = 255 dec) and Sourced Current = 200µA		4.7		V	
COmin	Minimum Cut-off Output Level	Min. Cut-off (Cut-off = 0 dec) and Sinked Current = 2mA		0.1		V	
COTD	Cut-off Output Voltage Drift	T _j Variation = 100°C		0.5		%	
COHIin	Maximum Cut-off Output Voltage (linear region)	Cut-off =235dec (Sourced Current = 200µA)		4.6		V	
COLlin	Minimum Cut-off Output Voltage (linear region)	Cut-off = 10 dec (Sinked current = 2mA)		0.17		V	
COstep	Cut-off Output Step (linear region)			20		mV	
FEEDBAC	K INPUTS (DC WITH FEEDBACK MO	DE)					
VFBmax VFBmin	Controlled Feedback Input Level Maximum Minimum	Max. Cut-off (Cut-off = 255 dec) Min. Cut-off (Cut-off = 1 dec)		2.5 20		V mV	
VFBstep	Controlled Feedback Input Level Step			10		mV	
IFB	input Current on Feedback inputs	$V \le 2.5V$		50		μA	
ABL (PIN 2	2)						
GABLmin GABLmax	ABL Mini Attenuation ABL Maxi Attenuation	V _{ABL} ≥3.2 V V _{ABL} = 1 V		0 15		dB dB	
V _{ABL}	ABL Threshold Voltage	For output attenuation		3		V	
IABLhigh IABLlow	High ABL Input Current Low ABL Input Current	V _{ABL} = 3.2V V _{ABL} = 1V		0 -2		μΑ μΑ	

9 - I²C ELECTRICAL CHARACTERISTICS

 T_{amb} = 25°C, V_{CCA} = 5V, unless otherwise specified

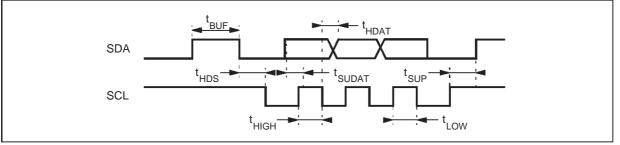
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
V _{IL}	Low Level Input Voltage	On Pins SDA, SCL			1.5	V
V _{IH}	High Level Input Voltage		3			V
I _{IN}	Input Current (Pins SDA, SCL)	0.4 V < V _{IN} < 4.5 V	-10		+10	μΑ
f _{SCL(Max.)}	SCL Maximum Clock Frequency		200		0.25	kHz
V _{OL}	Low Level Output Voltage	SDA Pin			0.6	V
* OL	Low Level Output Voltage	when ACK Sink Current = 6mA			0.0	V

10 - I²C INTERFACE TIMING REQUIREMENTS

(see Figure 11)

Symbol	Parameter	Min.	Тур.	Max.	Units
t _{BUF}	Time the bus must be free between two accesses	1300			ns
t _{HDS}	Hold Time for Start Condition	600			ns
t _{SUP}	Set-up Time for Stop Condition	600			ns
t _{LOW}	The Low Period of Clock	1300			ns
t _{HIGH}	The High Period of Clock	600			ns
t _{HDAT}	Hold Time Data	300			ns
t _{SUDAT}	Set-up Time Data	250			ns
t _R , t _F	Rise and Fall Time of both SDA and SCL	20		300	ns

Figure 10. I²C Timing Diagram



11 - I²C REGISTER DESCRIPTION

Register Sub-addressed - I²C Table 1

Sub-a	ddress	Register Names	POR	Value	Max. Value		
Hex	Dec		Hex	Dec	Hex	Dec	
01	01	Contrast (CRT)	8-bit DAC	B4	180	FE	254
02	02	Brightness (BRT)	8-bit DAC	B4	180	FF	255
03	03	Drive 1 (DRV)	8-bit DAC	B4	180	FE	254
04	04	Drive 2 (DRV)	8-bit DAC	B4	180	FE	254
05	05	Drive 3 (DRV)	8-bit DAC	B4	180	FE	254
06	06	Output DC Level (DCL)	4-bit DAC	09	09	0F	15
07	07	OSD Contrast (OSD)	4-bit DAC	09	09	0F	15
08	08	BPCP & OCL	Refer to the I ² C table 2	04	04		
09	09	Miscellaneous	Refer to the I ² C table 3	1C	28		
0A	10	Cut Off Out 1 DC Level (Cut-off)	8-bit DAC	B4	180	FF	255
0B	11	Cut Off Out 2 DC Level (Cut-off)	8-bit DAC	B4	180	FF	255
0C	12	Cut Off Out 3 DC Level (Cut-off)	8-bit DAC	B4	180	FF	255
0D	13	Bandwidth Adjustment (BW)	4-bit DAC	07	07	0F	15

For Contrast & Drive adjustment, code 00 (dec) and 255 (dec) are not allowed.

For Output DC Level, code 00(dec), 01(dec), 02(dec) are not allowed (Register 06).

For Cut Off Output DC Level, output voltage is linear between code 10 and code 235 (Registers 0A, 0B, 0C).

BPCP & OCL Register (R8) - I²C Table 2 (see also Figure12)

b7	b6	b5	b4	b3	b2	b1	b0	Function	POR Value
			0				0	Internal BPCP triggered by HSYNC	х
			0				1	Internal BPCP triggered by BLK	
			0			0		Internal BPCP synchronized by the trailing edge	x
			0			1		Internal BPCP synchronized by the leading edge	
			0	0	0			Internal BPCP Width = 0.33 µs	
			0	0	1			Internal BPCP Width = 0.66 μs	x
			0	1	0			Internal BPCP Width = 1 µs	
			0	1	1			Internal BPCP Width = 1.33 μs	
			1					Internal BPCP = BPCP input (Pin 23)	
		0						Normal Operation	х
		1						Reserved (Force BPCP to 1 in test)	
	0							Normal Operation	x
	1							Reserved (Force OCL to 1 in test)	
0								Internal OCL pulse triggered by BLK (pin 24)	x
1								Internal OCL pulse = Internal BPCP	

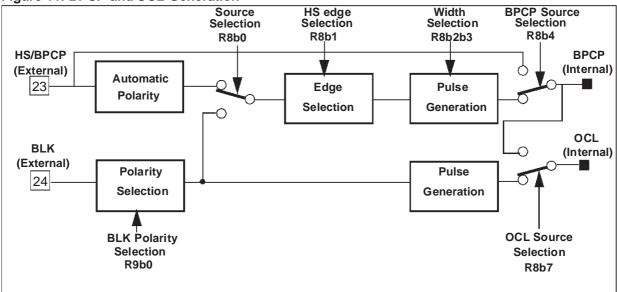
b7	b6	b5	b4	b3	b2	b1	b0	Function	POR Value
							0	Positive Blanking Polarity	х
							1	Negative Blanking Polarity	
						0		Soft Blanking = OFF	x
						1		Soft Blanking = ON	
			1	1	1			AC Coupling Mode or DC with Cut-off control	х
			х	0	1			DC Coupling Mode	
			0	Х	0			DC Coupling with Feedback Mode	
	0	0						Light Grey on OSD Outputs = OFF	х
	0	1						Light Grey on OSD Outputs = ON	
	0	0						Dark Grey on OSD Outputs = OFF	х
	1	0						Dark Grey on OSD Outputs = ON	
0								SOG Clipping = OFF	х
1								SOG Clipping = ON	

Miscellaneous Register (R9) - I²C Table 3

Bandwidth Adjustment (R13) - I²C Table 4

b7	b6	b5	b4	b3	b2	b1	b0	Function	POR Value
				1	1	1	1	130 MHz	
				0	1	1	1	100 MHz	х
				0	0	0	0	80 MHz	
		0	0					Normal Operation	х
		0	1					BW DAC output connected to BLK input (for test)	
		1	0					BW DAC complementary output connected to BLK input (for test)	

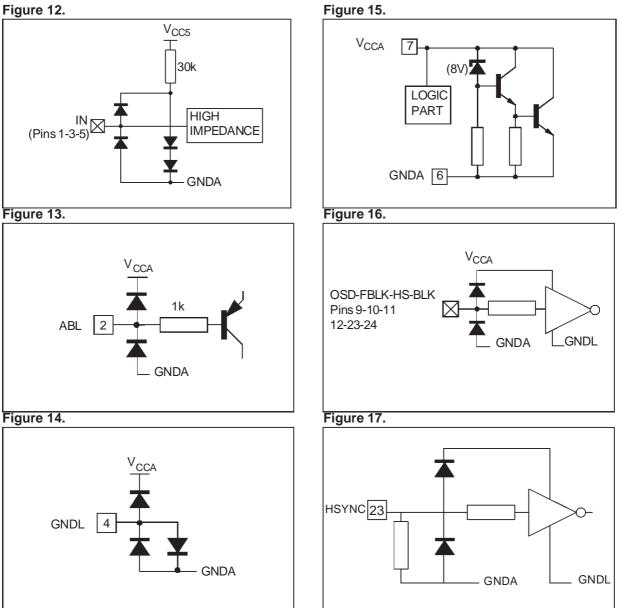
Figure 11. BPCP and OCL Generation



12 - INTERNAL SCHEMATICS

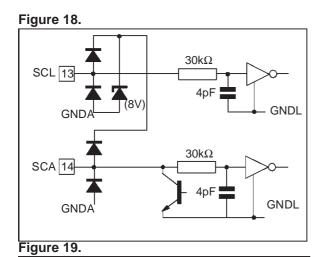
Figure 12.

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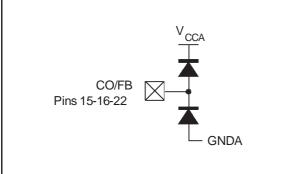
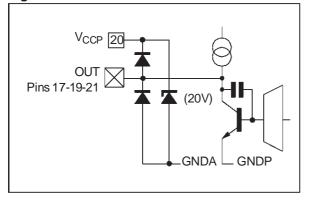
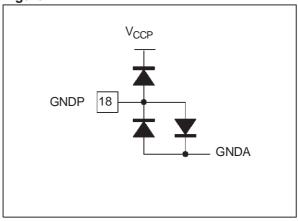
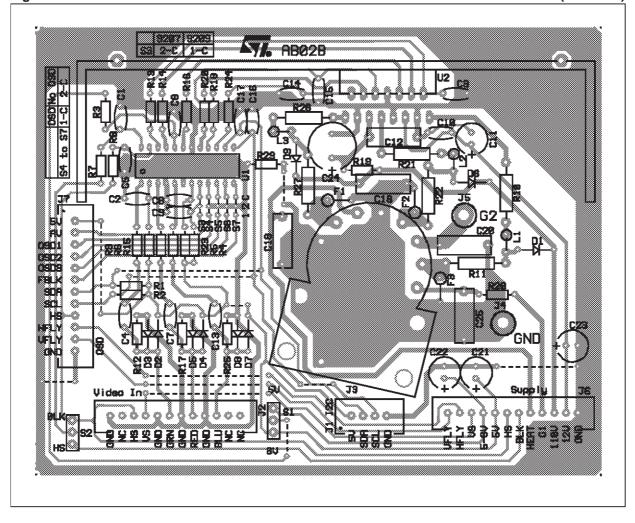


Figure 20.





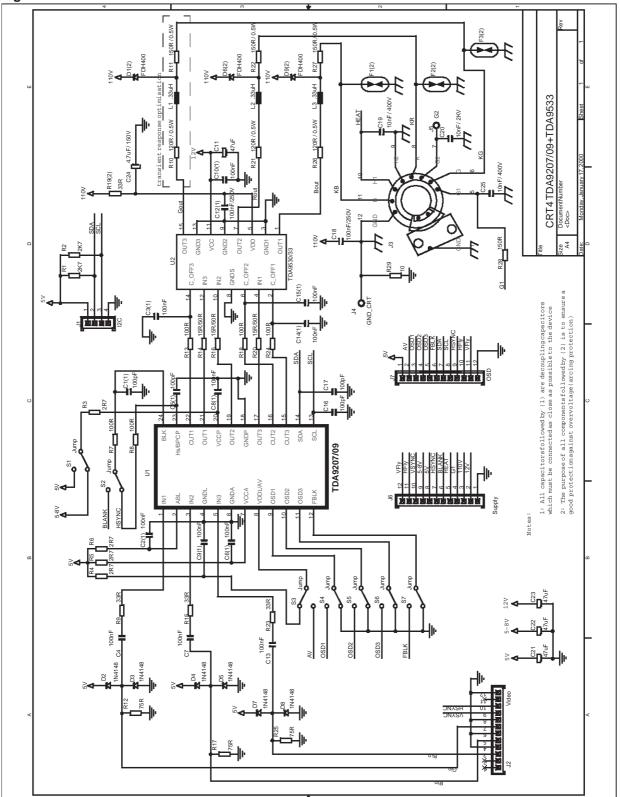




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Figure 22. TDA9207/9209 - TDA9533/9530 Demonstration Board: Silk Screen and Trace (scale 1:1)

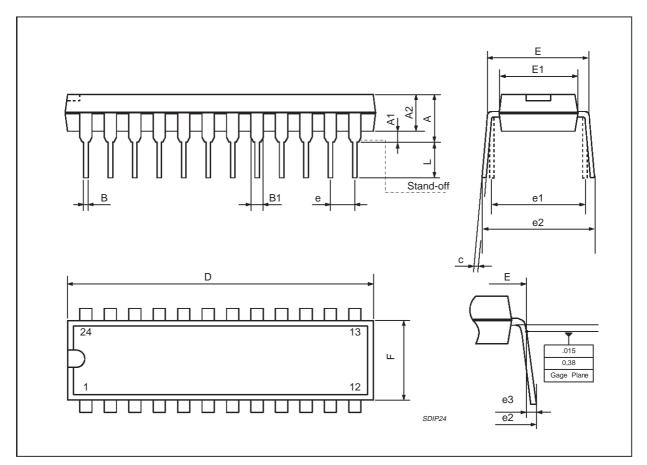
TDA9207





PACKAGE MECHANICAL DATA

24 Pins — Plastic Dip (Shrink))



Dimensions		Millimeters		Inches				
Dimensions	Min.	Тур.	Max.	Min.	Тур.	Max.		
A			5.08			0.20		
A1	0.51			0.020				
A2	3.05	3.30	4.57	0.120	0.130	0.180		
В	0.36	0.46	0.56	0.0142	0.0181	0.0220		
B1	0.76	1.02	1.14	0.030	0.040	0.045		
С	0.23	0.25	0.38	0.0090	0.0098	0.0150		
D	22.61	22.86	23.11	0.890	0.90	0.910		
E	7.62		8.64	0.30		0.340		
E1	6.10	6.40	6.86	0.240	0.252	0.270		
е		1.778			0.070			
e1		7.62			0.30			
e2			10.92			0.430		
e3			1.52			0.060		

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